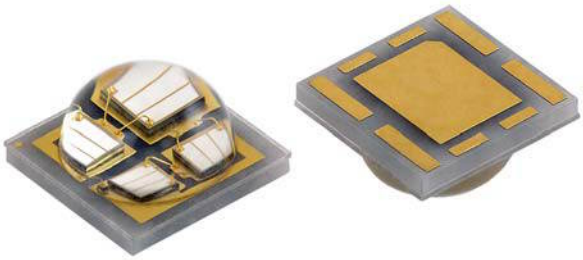
UV SMD LED with Silicone Lens



DESCRIPTION

The VLMU5200-...-140 series comprises 3 high brightness UV LED types within an overall wavelength range from 380nm to 410nm. The ceramic based high power package with silicone lens features a good longterm stability against thermal exposure and UV light irradiation and therefore a long life time. The package size is 5.2 mm x 5.2 mm x 3.1 mm, and the radiant power up to 4400 mW at 700 mA, with 4 LED chips connected in series.

PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- Package: SMD ceramic high power
- Product series: high power UV LED
- Angle of half intensity: ± 70°
- Lead-finishing: Au

SAFETY ADVICES

Depending on the mode of operation, these devices emit highly concentrated non visible ultraviolet light which can be hazardous to the human eye. Products which incorporate these devices have to follow the safety precautions given in IEC 62471 “Photobiological Safety of Lamp and Lamp Systems”.

FEATURES

- Ceramic SMT package with silicone lens
- Dimensions (L x W x H) in mm: 5.2 x 5.2 x 3.1
- Forward current: up to 700 mA
- Radiant power (typ.): 2500 mW at 500 mA, 3600 mW at 700 mA
- Materials:
  - Die: InGaN
  - Resin: silicone (water clear)
  - L / F finish: AlN with Au plating
- Grouping parameters:
  - Radiant power
  - Peak wavelength
  - Forward voltage
- Reflow soldering method
- MSL2 according to J-STD-020
- Packaging: 12 mm tape with 100 pieces per reel, Ø 180 mm (7")
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Pb-free

e4

RoHS COMPLIANT

HALOGEN FREE

GREEN (5-2008)

APPLICATIONS

- Industrial curing
- Photocatalytic purification
- Poster printing curing
- Counterfeit money detector
- Blood detector
- Nail curing
- Teeth curing

PARTS TABLE

PART	COLOR	RADIANT POWER (mW)			at I_F (mA)	WAVELENGTH (nm)			at I_F (mA)	FORWARD VOLTAGE (V)			at I_F (mA)	TECHNOLOGY
		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		
VLMU5200-385-140	Ultraviolet	1800	2500	3300	500	380	385	390	500	13	14.5	16	500	InGaN
VLMU5200-395-140	Ultraviolet	1800	2500	3300	500	390	395	400	500	13	14.5	16	500	InGaN
VLMU5200-405-140	Ultraviolet	1800	2500	3300	500	400	405	410	500	13	14.5	16	500	InGaN

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified) **VLMU5200-...-140**				
PARAMETER	**TEST CONDITION**	**SYMBOL**	**VALUE**	**UNIT**
DC forward current		I_F	700	mA
Power dissipation		P_V	11.2	W
Electrostatic discharge	HBM: MIL-STD-883 C 3B	ESD	2000	V
Junction temperature		T_j	+150	°C
Operating temperature range		T_{amb}	-40 to +85	°C
Storage temperature range		T_{stg}	-40 to +100	°C
Solder temperature		T_{sol}	260	°C
Thermal resistance - junction to solder point		R_{thJS}	2.4	°C/W

OPTICAL AND ELECTRICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified) **VLMU5200-...-140, ULTRAVIOLET**							
PARAMETER	**TEST CONDITION**	**DEVICE TYPE**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Forward voltage	I_F = 500 mA		V_F	13.0	14.5	16.0	V
Radiant power	I_F = 350 mA		ϕ_e	1300	1950	2350	mW
	I_F = 500 mA			1800	2500	3300	
	I_F = 700 mA			2480	3600	4400	
Ratio: radiant intensity / radiant power	I_F = 500 mA		I_e	-	0.28	-	sr^{-1}
Peak wavelength	I_F = 500 mA	VLMU5200-385-140	λ_p	380	385	390	nm
		VLMU5200-395-140		390	395	400	nm
		VLMU5200-405-140		400	405	410	nm
Angle of half intensity	I_F = 500 mA		φ	-	± 70	-	deg

Note

- Tolerances: ± 11 % for ϕ_e, ± 0.1 V for V_F, ± 2 nm for λ_p.

RADIANT POWER CLASSIFICATION (I_F = 500 mA)			
GROUP	**MIN.**	**MAX.**	**UNIT**
PA8	1800	1900	mW
PA9	1900	2000	
PB0	2000	2100	
PB1	2100	2200	
PB2	2200	2300	
PB3	2300	2400	
PB4	2400	2500	
PB5	2500	2600	
PB6	2600	2700	
PB7	2700	2800	
PB8	2800	2900	
PB9	2900	3000	
PC0	3000	3100	
PC1	3100	3200	
PC2	3200	3300	

PEAK WAVELENGTH CLASSIFICATION (I_F = 500 mA)			
GROUP	**MIN.**	**MAX.**	**UNIT**
Q380	380	385	nm
Q385	385	390	
Q390	390	395	
Q395	395	400	
Q400	400	405	
Q405	405	410	

FORWARD VOLTAGE CLASSIFICATION (I_F = 500 mA)			
GROUP	**MIN.**	**MAX.**	**UNIT**
W1314	13.0	14.0	V
W1415	14.0	15.0	
W1516	15.0	16.0	

Note

- In order to ensure availability, single groups for radiant intensity, wavelength, and forward voltage will not be orderable. Only one group for radiant intensity, wavelength, and forward voltage will be shipped in any one reel.

MARKING EXAMPLE FOR SELECTION CODE ON LABEL

Selection code: PA9Q385W1415

PA9 → ϕ_e

Q385 → λ_p

W1415 → V_F

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

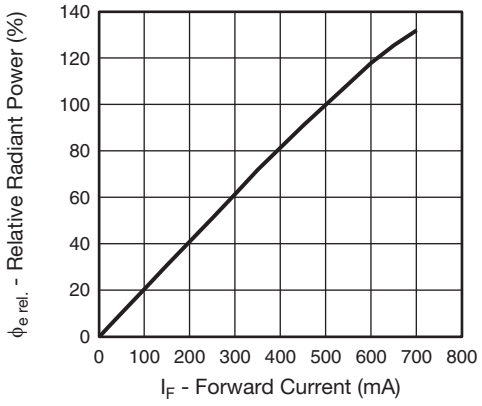


Fig. 1 - Relative Radiant Power vs. Forward Current

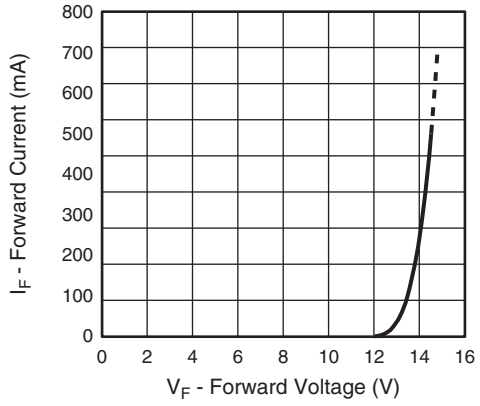


Fig. 2 - Forward Current vs. Forward Voltage

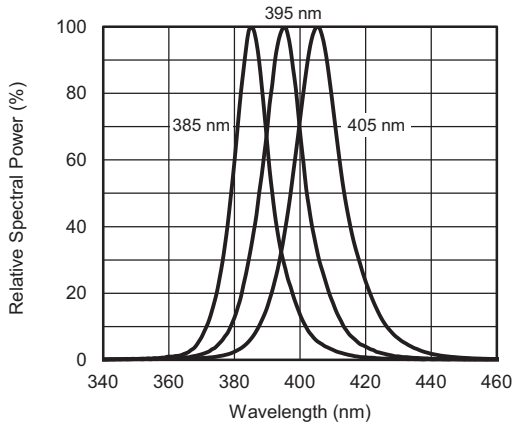


Fig. 3 - Relative Spectral Power vs. Wavelength

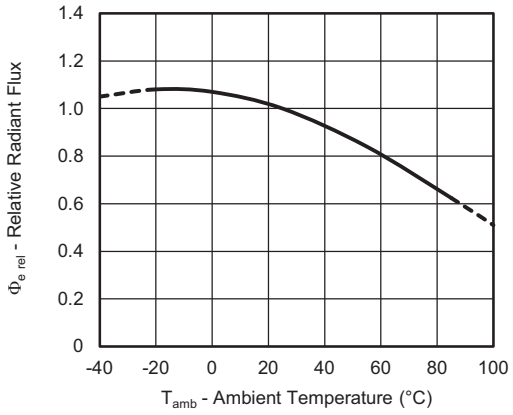


Fig. 6 - Relative Radiant Flux vs. Ambient Temperature

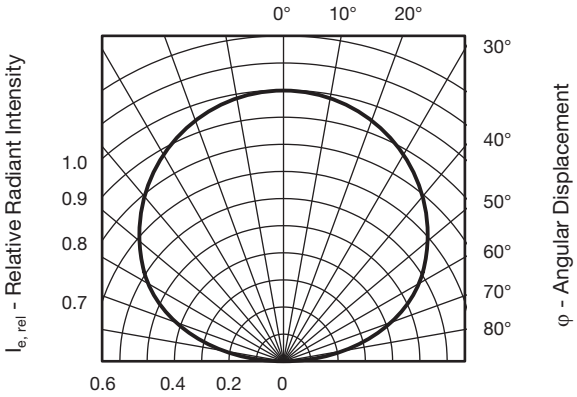


Fig. 4 - Relative Intensity vs. Wavelength

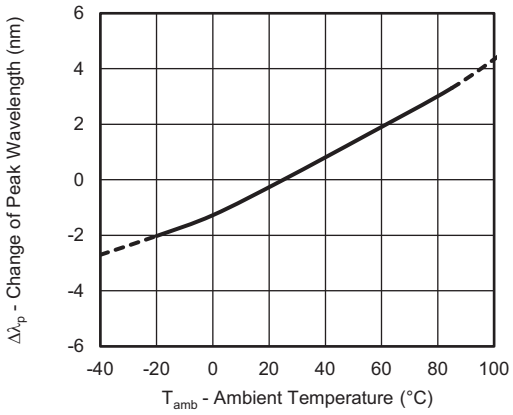


Fig. 7 - Change of Peak Wavelength vs. Ambient Temperature

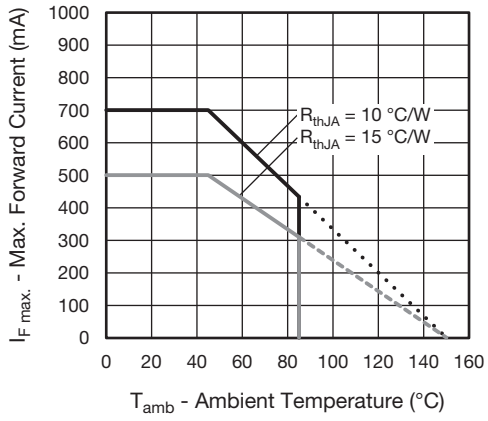


Fig. 5 - Maximum Forward Current vs. Ambient Temperature

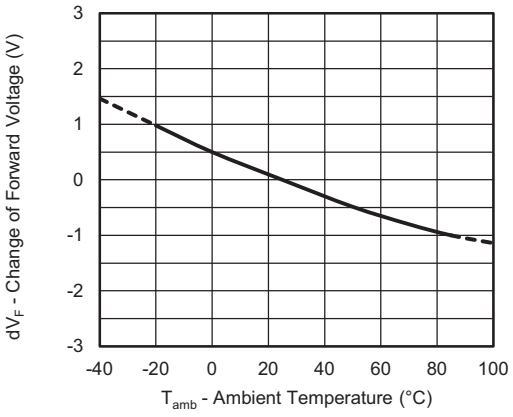
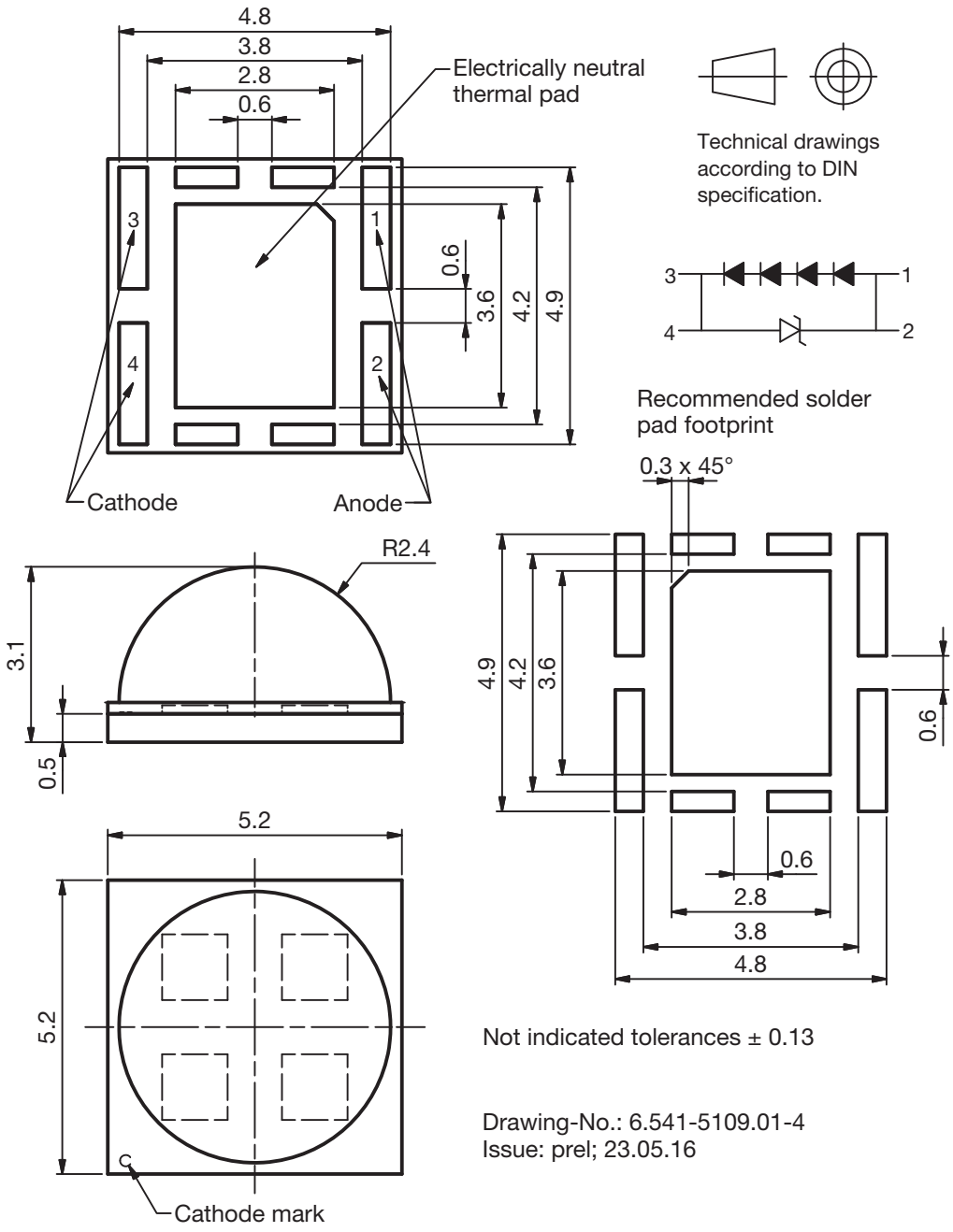


Fig. 8 - Change of Forward Voltage vs. Ambient Temperature

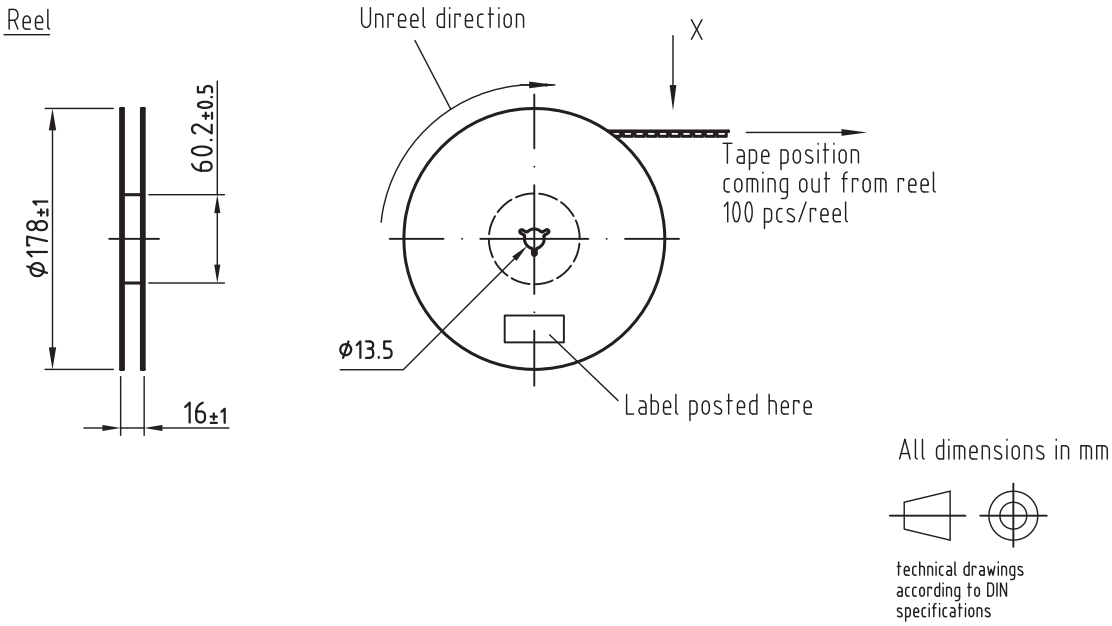
PACKAGE DIMENSIONS in millimeters



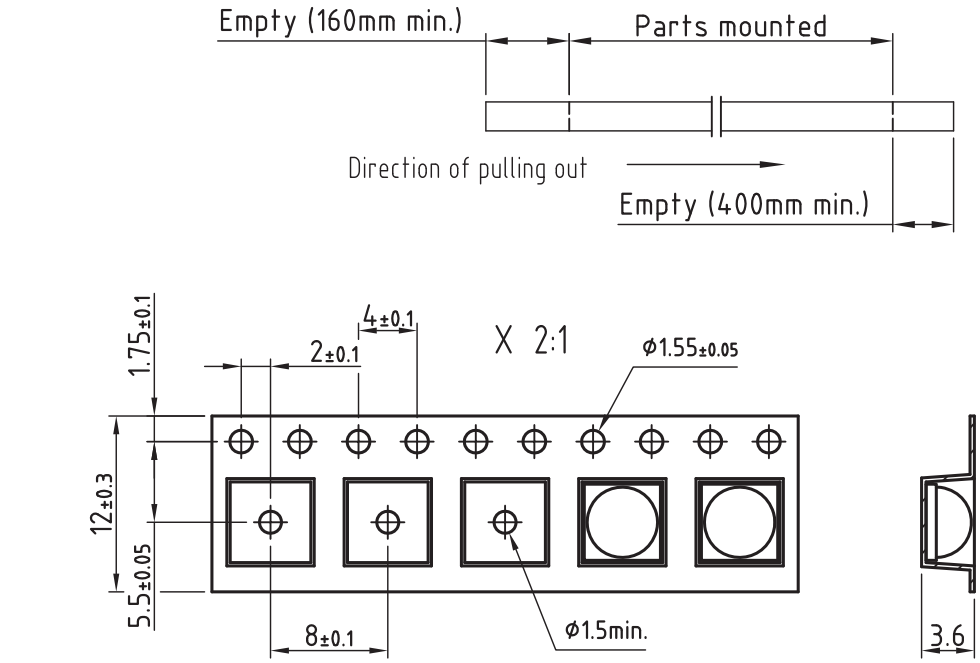
Not indicated tolerances ± 0.13

Drawing-No.: 6.541-5109.01-4
Issue: prel; 23.05.16

TAPE AND REEL DIMENSIONS in millimeters



Leader and trailer tape:



Drawing refers to following types: VLMU5200-385-140
Reel dimensions and tape

Drawing-No.: 9.800-5135.01-4
Issue: prel; 29.05.15

SOLDERING PROFILE

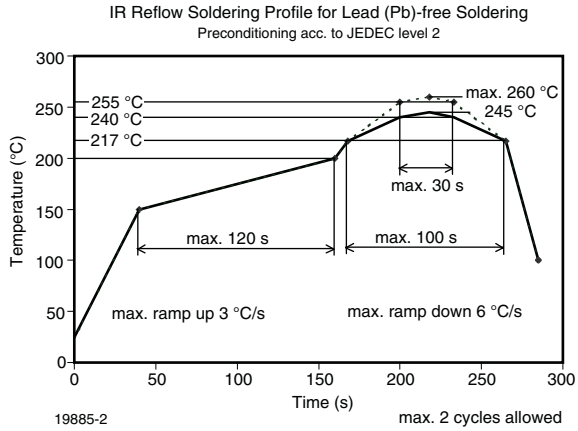
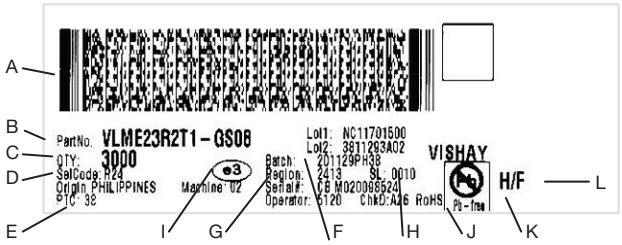


Fig. 9 - Vishay Lead (Pb)-free Reflow Soldering Profile (acc. to J-STD-020C)

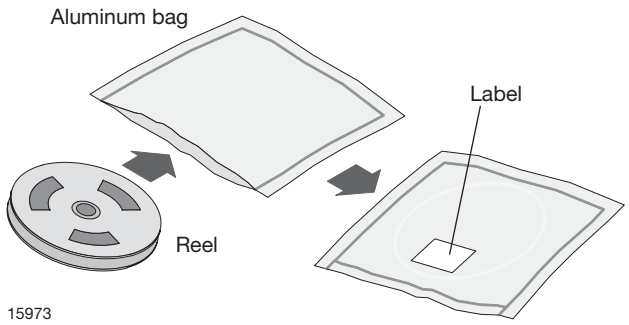
BAR CODE PRODUCT LABEL (example only)



A. 2D barcode
B. Vishay part number
C. Quantity
D. SEL = selection code (binning)
E. Code of manufacturing plant
F. Batch = date code: year / week / plant code
G. Region code
H. SL = sales location
I. Terminations finishing
J. Lead (Pb)-free symbol
K. Halogen-free symbol
L. RoHS symbol

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 1 year under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or
24 h at 60 °C + 5 °C and < 5 % RH for all device containers or
24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard JESD22-A112 level 2 label is included on all dry bags.

Example of JESD22-A112 level 2 label

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

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